# FDS4435

## 30V P-Channel PowerTrench<sup>®</sup> MOSFET

#### **General Description**

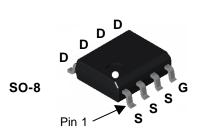
This PChannel MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications requiring a wide range of gave drive voltage ratings (4.5V - 25V).

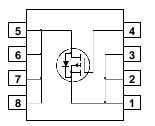
#### Applications

- Power management
- · Load switch
- Battery protection

#### Features

- -8.8 A, -30 V  $R_{DS(ON)} = 20 \text{ m}\Omega @ \text{V}_{GS} = -10 \text{ V}$  $R_{DS(ON)} = 35 \text{ m}\Omega @ \text{V}_{GS} = -4.5 \text{ V}$
- Low gate charge (17nC typical)
- · Fast switching speed
- + High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





### Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

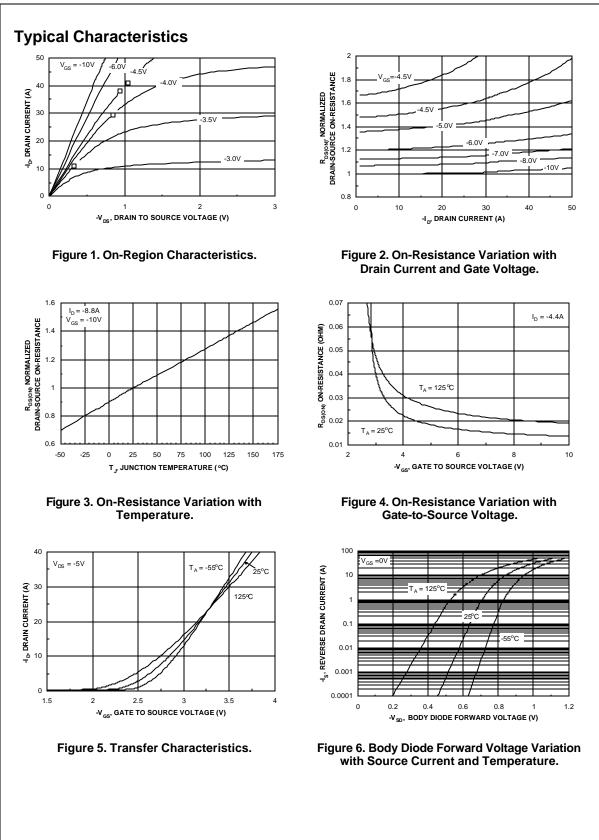
Symbol	Parameter			Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage			-30	V
V <sub>GSS</sub>	Gate-Source	e Voltage		±25	V
D	Drain Currer	nt – Continuous	(Note 1a)	-8.8	А
		– Pulsed		-50	
PD	Power Dissi	pation for Single Operation	(Note 1a)	2.5	W
			(Note 1b)	1.2	
			(Note 1c)	1	
T <sub>J</sub> , T <sub>STG</sub>	Operating ar	nd Storage Junction Tempe	rature Range	-55 to +175	
Therma	I Charact	eristics			
R <sub>0JA</sub>	Thermal Resistance, Junction-to-Ambient (Note 1a)		nt (Note 1a)	50	°C/W
R <sub>0JA</sub>	Thermal Resistance, Junction-to-Ambient (Note 1c)		nt (Note 1c)	125	°C/W
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case (Note 1)			25 °	
Packag	e Marking	g and Ordering In	formation		
Device Marking		Device	Reel Size	Tape width	Quantity
FDS4435		FDS4435	13"	12mm	2500 units

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FDS4435

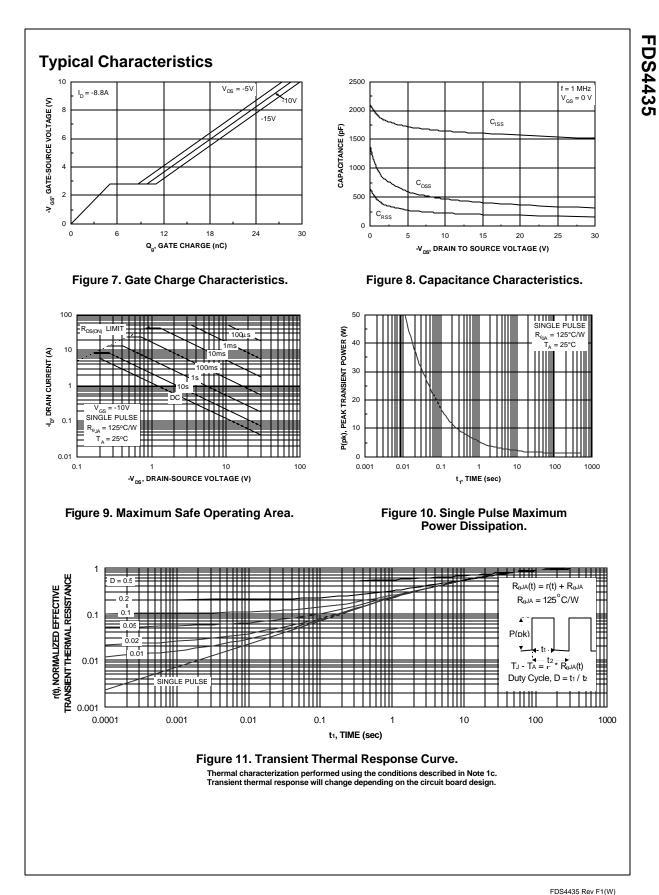
	Test Conditions	Min	Тур	Max	Units
acteristics		1	<u> </u>		1
Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = -250 \mu A$	-30		[	V
Breakdown Voltage Temperature	$I_{\rm D} = -250 \mu\text{A}$ , Referenced to 25°C		-21		mV/ºC
Coefficient			-21	<u> </u>	
Zero Gate Voltage Drain Current		Ļ	<u> </u>	-1	μA
Gate–Body Leakage, Forward			<u> </u>	100	nA
Gate–Body Leakage, Reverse	$V_{GS} = -25 \text{ V},  V_{DS} = 0 \text{ V}$	<u> </u>		-100	nA
Acteristics (Note 2)			<u>.                                    </u>	. <u> </u>	<u>.                                    </u>
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-1	-1.7	-3	V
	$I_D = -250 \ \mu$ A, Referenced to 25°C	Γ	5	ĺ	mV/°C
Static Drain–Source	$V_{GS} = -10 \text{ V},  I_D = -8.8 \text{ A}$	<u> </u>	15	20	mΩ
On-Resistance	$V_{GS} = -4.5 \text{ V},  I_D = -6.7 \text{ A}$		22	35	
	$V_{GS}$ = -10 V, $I_D$ = -8.8A, T <sub>J</sub> =125°C		19	32	
On–State Drain Current	$V_{GS} = -10 \text{ V}, \qquad V_{DS} = -5 \text{ V}$	-50			A
Forward Transconductance	$V_{DS} = -5 V$ , $I_D = -8.8 A$		24		S
Characteristics					
Input Capacitance	$V_{DS} = -15 V$ , $V_{GS} = 0 V$ ,		1604		pF
Output Capacitance	f = 1.0 MHz		408		pF
Reverse Transfer Capacitance	1		202		pF
- Characteristics (Note 2)		1		·	L
	$V_{22} = -15 V$ $b = -1 A$	1	13	23	ns
,	$V_{GS} = -10 V$ , $R_{GEN} = 6 \Omega$		-	-	ns
					ns
,	1				ns
	$V_{22} = -15 V$ $h = -8.8 A$		-		nC
8	$V_{GS} = -5 V$			27	nC
5	1		-		nC
5		<u> </u>	U	<u> </u>	10
		<del></del>	<del></del>	21	
		<u> </u>	<u> </u>		A
Voltage	$V_{GS} = 0 V$ , $I_S = -2.1 A$ (Note 2)		-0.73	-1.2	V
	Zero Gate Voltage Drain Current Gate–Body Leakage, Forward Gate–Body Leakage, Reverse Cteristics (Note 2) Gate Threshold Voltage Gate Threshold Voltage Gate Threshold Voltage Temperature Coefficient Static Drain–Source On–Resistance On–State Drain Current Forward Transconductance Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance g Characteristics (Note 2) Turn–On Delay Time Turn–Off Delay Time Turn–Off Fall Time Total Gate Charge Gate–Source Charge Gate–Drain Charge Urce Diode Characteristics a Maximum Continuous Drain–Source Drain–Source Diode Forward	Zero Gate Voltage Drain Current $V_{DS} = -24 \text{ V}$ , $V_{GS} = 0 \text{ V}$ Gate-Body Leakage, Forward $V_{GS} = 25 \text{ V}$ , $V_{DS} = 0 \text{ V}$ Gate-Body Leakage, Reverse $V_{GS} = -25 \text{ V}$ , $V_{DS} = 0 \text{ V}$ Cteristics(Note 2)Gate Threshold Voltage $b_{DS} = -250 \mu \text{A}$ , Referenced to 25°CTemperature Coefficient $b_{DS} = -250 \mu \text{A}$ , Referenced to 25°CStatic Drain-Source $V_{GS} = -10 \text{ V}$ , $b_{D} = -8.8 \text{ A}$ On-Resistance $V_{GS} = -10 \text{ V}$ , $b_{D} = -8.8 \text{ A}$ On-State Drain Current $V_{GS} = -10 \text{ V}$ , $V_{DS} = -5 \text{ V}$ Forward Transconductance $V_{DS} = -5 \text{ V}$ , $b_{D} = -8.8 \text{ A}$ CharacteristicsNons = -5 V, $b_{D} = -8.8 \text{ A}$ Input Capacitance $V_{DS} = -15 \text{ V}$ , $V_{GS} = 0 \text{ V}$ ,f = 1.0 MHzTurn-On Delay TimeTurn-On Delay Time $V_{DS} = -15 \text{ V}$ , $b_{D} = -1 \text{ A}$ ,Turn-Off Delay Time $V_{DS} = -10 \text{ V}$ , $R_{GEN} = 6 \Omega$ Turn-Off Delay Time $V_{DS} = -15 \text{ V}$ , $b_{D} = -8.8 \text{ A}$ ,Turn-Off Fall Time $V_{CS} = -10 \text{ V}$ , $R_{GEN} = 6 \Omega$ Turn-Off Fall Time $V_{CS} = -5 \text{ V}$ Total Gate Charge $V_{DS} = -5 \text{ V}$ Gate-Drain Charge $V_{CS} = -5 \text{ V}$ Maximum Continuous Drain-Source Diode Forward CurrentDrain-Source Diode Forward $V_{CS} = 0 \text{ V}$ , $b_{D} = -21 \text{ A}$ , (Note 2)	Zero Gate Voltage Drain Current $V_{DS} = -24 \text{ V},  V_{GS} = 0 \text{ V}$ Gate-Body Leakage, Forward $V_{GS} = 25 \text{ V},  V_{DS} = 0 \text{ V}$ Gate-Body Leakage, Reverse $V_{GS} = -25 \text{ V},  V_{DS} = 0 \text{ V}$ Cteristics(Note 2)Gate Threshold Voltage $V_{DS} = V_{GS}, \text{ b} = -250 \mu\text{A}$ -1Gate Threshold Voltage $V_{DS} = V_{GS}, \text{ b} = -250 \mu\text{A}$ -1Gate Threshold Voltage $V_{DS} = -250 \mu\text{A}, \text{ Referenced to } 25^{\circ}\text{C}$ Temperature Coefficient $V_{GS} = -10 \text{ V},  b = -8.8 \text{ A}$ Static Drain-Source $V_{GS} = -10 \text{ V},  b = -8.8 \text{ A}$ On-Resistance $V_{GS} = -10 \text{ V},  b = -8.8 \text{ A}$ On-State Drain Current $V_{GS} = -10 \text{ V},  b = -8.8 \text{ A}$ CharacteristicsInput Capacitance $V_{DS} = -5 \text{ V},  b = -8.8 \text{ A}$ CharacteristicsNote 2)Input CapacitanceInput Capacitance $V_{DS} = -15 \text{ V},  V_{GS} = 0 \text{ V}, \text{ f} = 1.0 \text{ MHz}$ Reverse Transfer CapacitanceImput Capacitance <b>g Characteristics</b> (Note 2)Turn-On Delay Time $V_{DS} = -15 \text{ V},  b = -1 \text{ A}, \text{ V}_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ Turn-Off Delay TimeV_{DS} = -15 \text{ V},  b = -8.8 \text{ A}, \text{ V}_{GS} = -5 \text{ V}Gate-Drain Charge $V_{DS} = -5 \text{ V}$ Gate-Drain Charge $V_{DS} = -5 \text{ V}$ Gate-Drain Charge $V_{DS} = -5 \text{ V}$ Maximum Continuous Drain-Source Diode Forward CurrentDrain-Source Diode Forward $V_{CS} = 0 \text{ V}$ Maximum Continuous Drain-Source Diode Forward Current	Zero Gate Voltage Drain Current $V_{DS} = -24 \text{ V}$ , $V_{GS} = 0 \text{ V}$ Gate-Body Leakage, Forward $V_{GS} = 25 \text{ V}$ , $V_{DS} = 0 \text{ V}$ Gate-Body Leakage, Reverse $V_{GS} = -25 \text{ V}$ , $V_{DS} = 0 \text{ V}$ Gate Threshold Voltage $V_{DS} = -250 \mu \text{A}$ $-1$ Gate Threshold Voltage $b = -250 \mu \text{A}$ , Referenced to $25^{\circ}\text{C}$ $5$ Gate Threshold Voltage $b = -250 \mu \text{A}$ , Referenced to $25^{\circ}\text{C}$ $5$ Static Drain-Source $V_{GS} = -10 \text{ V}$ , $b = -8.8 \text{ A}$ $15$ On-Resistance $V_{GS} = -10 \text{ V}$ , $b = -6.7 \text{ A}$ $22$ $V_{GS} = -10 \text{ V}$ , $b = -8.8 \text{ A}$ , $T_J = 125^{\circ}\text{C}$ $19$ On-State Drain Current $V_{GS} = -10 \text{ V}$ , $V_{DS} = -5 \text{ V}$ $-50$ Forward Transconductance $V_{DS} = -5 \text{ V}$ , $b = -8.8 \text{ A}$ $24$ <b>Characteristics</b> Input Capacitance $V_{DS} = -15 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $1604$ Output Capacitance $V_{DS} = -15 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $1604$ Output Capacitance $V_{DS} = -15 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $13.5$ Turn-On Rise Time $V_{DS} = -15 \text{ V}$ , $b = -1 \text{ A}$ , $13$ Turn-On Rise Time $V_{DS} = -15 \text{ V}$ , $b = -1 \text{ A}$ , $13.2$ Turn-Off Belay Time $V_{DS} = -5 \text{ V}$ $5$ Gate-Source Charge $V_{DS} = -5 \text{ V}$ $5$ Gate-Source Charge $V_{OS} = -5 \text{ V}$ $5$ Gate-Drain Charge $V_{OS} = -5 \text{ V}$ $5$ Maximum Continuous Drain-Source Diode Forward Current $-0.73$	Zero Gate Voltage Drain Current $V_{DS} = -24$ V, $V_{GS} = 0$ V-1Gate-Body Leakage, Forward $V_{GS} = 25$ V, $V_{DS} = 0$ V100Gate-Body Leakage, Reverse $V_{GS} = -25$ V, $V_{DS} = 0$ V-100 <b>Cteristics</b> (Note 2)Gate Threshold Voltage $V_{DS} = V_{GS}$ , $b = -250 \mu$ A-1Gate Threshold Voltage $b = -250 \mu$ A, Referenced to $25^{\circ}$ C5Temperature Coefficient $b = -250 \mu$ A, Referenced to $25^{\circ}$ C5Static Drain–Source $V_{GS} = -10$ V, $b = -8.8$ A20On-Resistance $V_{GS} = -10$ V, $b = -8.8$ A22On-State Drain Current $V_{GS} = -10$ V, $V_{DS} = -5$ V-50Forward Transconductance $V_{DS} = -5$ V, $b = -8.8$ A24 <b>Characteristics</b> 1604Input Capacitance $V_{DS} = -15$ V, $V_{GS} = 0$ V,1604Output Capacitance $V_{DS} = -15$ V, $b = -1$ A,1323Turn–On Delay Time $V_{GS} = -10$ V, $R_{GEN} = 6$ Ω13.524Turn–Off Belay Time $V_{DS} = -5$ V $b = -3.8$ A,1724Gate-Source Charge $V_{DS} = -15$ V, $b = -8.8$ A,1724Gate-Source Charge $V_{OS} = -5$ V55Gate-Drain Charge $V_{OS} = -5$ V55Maximum Continuous Drain–Source Diode Forward Current $-2.1$ $-0.73$ $-12$ </td

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